

DECLARATION FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship is as stated below next to my name;

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

THE USE OF ENDOPHYTIC FUNGI TO TREAT PLANTS									
the specification of I have reviethe claims, as ame	ewed and under		No.: ided on: ents of the		entified sp	ecification,			
information which is material to patentability as defined in 37 C.F.R. § 1.56.									
Prior Foreign Application(s)									
I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:									
Country	Application Number	Foreign Fil (DD/MM/		Priority)	Claimed	Certifie Attac	l Copy hed		
The state of the s				Yes 🗌	No 🗌	Yes 🗌	No 🗌		
				Yes 🗌	No 🗌	Yes 🗌	No 🗌		
				Yes	No 🗌	Yes 🗌	No 🗌		
Prior Provisional Application(s)									
l hereby cla provisional applicat	aim priority und	er Title 35, Ur	• •	• •	119(e) of	any Unite	d States		
. ;	Application Number		Date of Filing (day, month, year)						
	60/390,515		June 21, 2002]			

Prior United States Application(s)

I hereby claim priority under Title 35, United States Code, §120 of any United States application(s), or § 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as

defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Number	Dat of Filing (day, month, year)	Status - Patented, Pending, Abandoned		

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. § 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Signature

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Date_ 11-12-03

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